# Bi-Directional Zener Diodes

## RSB27F2

#### Outline

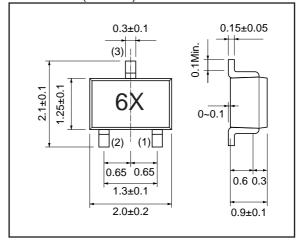
RSB27F2 is a bi-directional zener diode having two zeners confronted in one package, aimed to absorb the surge in plus and minus directions arising from the signal line in mobile phone, consumer electronics such as PC, and automotive applications.

In general, two pieces of zener diodes are used as ESD protector to absorb the surge in +/ - directions. Paying attention to this point and using its original technology, ROHM succeeded to incorporate 2 zeners in one die / package for benefit of space-saving on the circuit board.

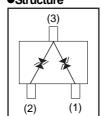
#### Features

- 1) Absorption of plus & minus surge with one package.
- 2) Decrease of components and space-saving on the circuit board.

### ●Dimensions (Unit: mm)



#### Structure



## ● Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Power dissipation (*1)	Pd	200	mW
Junction temperature	Tj	150	°C
Operation temperature range	Tstg	-55 to +150	°C

<sup>(\*1)</sup> Total of 2 elements

### ●Electrical characteristics (Ta=25°C) (Rating of per diode)

Parameter	Symbol	Min.	Max.	Unit	Conditions
Zener voltage	$V_z$	26.2	32.0	V	I <sub>F</sub> =1mA
Reverse current	$I_R$	-	0.1	μA	V <sub>R</sub> =24V
Capacitance between terminals	Ct	-	30	pF	V <sub>R</sub> =0V , f=1MHz

<sup>\*</sup> Zener voltage to be measured at 40ms after current starting to apply.



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSIII	CLASSIIb	СГУССШ	
CLASSIV		CLASSⅢ	CLASSIII	

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

## **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

QR code printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

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